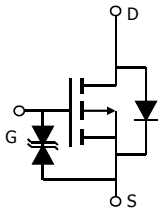
AO3415

P-Channel MOSFET

FEATURES

- The AO3415 uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch applications.



1.Gate
2.Source
3.Drain

SOT-23

Absolute Maximum Ratings (TA=25oC, unless otherwise noted)

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	-20	V
Gate-Source Voltage		V_{GS}	±8	V
Continuous Drain Current	T_A=25℃	I_D	-4	A
	T_A=70℃		-3.5	
Pulsed Drain Current [C]		I_{DM}	-30	
Power Dissipation [B]	T_A=25℃	P_D	1.5	W
	T_A=70℃		1	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	℃

Thermal Characteristics

Parameter		Symbol	Typ	Max	Units
Maximum Junction-to-Ambient [A]	t ≤ 10s	R	65	80	℃/W
Maximum Junction-to-Ambient [A D]	Steady-State		85	100	℃/W
Maximum Junction-to-Lead	Steady-State	R_{JL}	43	52	℃/W

AO3415

Electrical Characteristics (TA=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=-250 A, V_{GS}=0V	-20			V
IDSS	Zero Gate Voltage Drain Current	V_{DS}=-20V, V_{GS}=0V			-1	uA
		T_J=55°C			-5	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}= ±8V			±10	uA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=-250	-0.3	-0.57	-0.9	V
$I_{D(ON)}$	On state drain current	V_{GS}=-4.5V, V_{DS}=-5V	-30			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=-4.5V, I_D=-4A		34	41	mΩ
		T_J=125℃		49	59	
		V_{GS}=-2.5V, I_D=-4A		42	53	mΩ
		V_{GS}=-1.8V, I_D=-2A		52	65	mΩ
		V_{GS}=-1.5V, I_D=-1A		61		mΩ
g_{FS}	Forward Transconductance	V_{DS}=-5V, I_D=-4A		20		S
V_{SD}	Diode Forward Voltage	I_S=-1A,V_{GS}=0V		-0.64	-1	V
I_S	Maximum Body-Diode Continuous Current				-2	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=-10V, f=1MHz	600	751	905	pF
C_{oss}	Output Capacitance		80	115	150	pF
C_{rss}	Reverse Transfer Capacitance		48	80	115	pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz	6	13	20	Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	V_{GS}=-4.5V, V_{DS}=-10V, I_D=-4A	7.4	9.3	11	nC
Q_{gs}	Gate Source Charge		0.8	1	1.2	nC
Q_{gd}	Gate Drain Charge		1.3	2.2	3.1	nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=-4.5V, V_{DS}=-10V, R_L=2.5Ω. R_{GEN}=3Ω		13		ns
t_r	Turn-On Rise Time			9		ns
$t_{D(off)}$	Turn-Off DelayTime			19		ns
t_f	Turn-Off Fall Time			29		ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=-4A, dI/dt=500A/ us	20	26	32	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=-4A, dI/dt=500A/ us	40	51	62	nC

A. The value of RθJA is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with TA =25°C. The value in any given application depends on the user's specific board design.
B. The power dissipation PD is based on TJ(MAX)
=150° C, using ≤ 10s junction-to-ambient thermal resistance.
C. Repetitive rating, pulse width limited by junction temperature TJ(MAX)
=150°C. Ratings are based on low frequency and duty cycles to keep
initialTJ=25°C.
D. The RθJA is the sum of the thermal impedance from junction to lead RθJL and lead to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, assuming a maximum junction temperature of TJ(MAX)
=150°C. The SOA curve provides a single pulse rating.

AO3415 Typical Characteristics

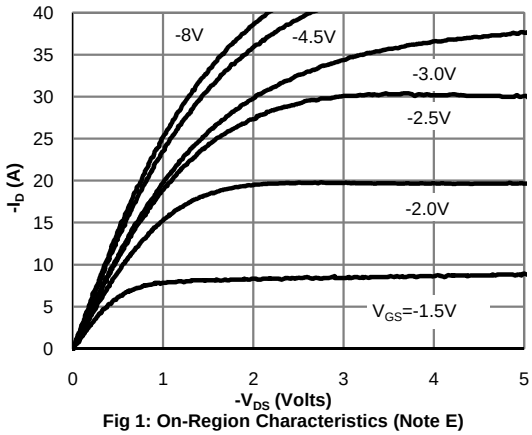


Fig 1: On-Region Characteristics (Note E)

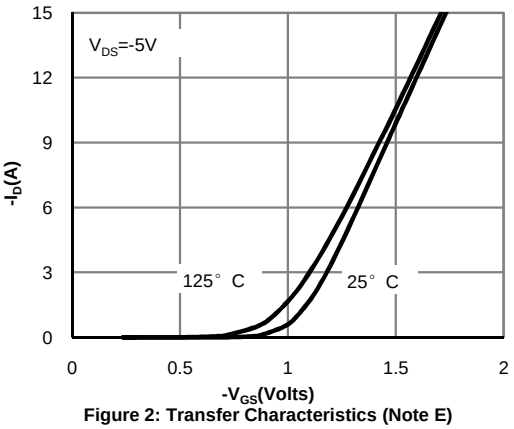


Figure 2: Transfer Characteristics (Note E)

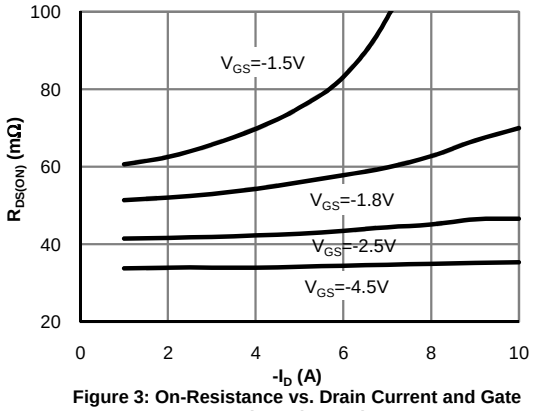


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

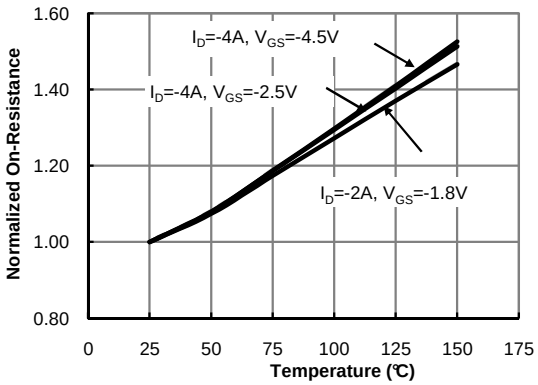


Figure 4: On-Resistance vs. Junction Temperature (Note E)

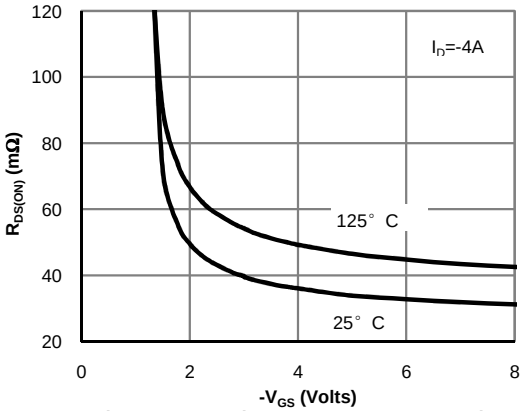


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

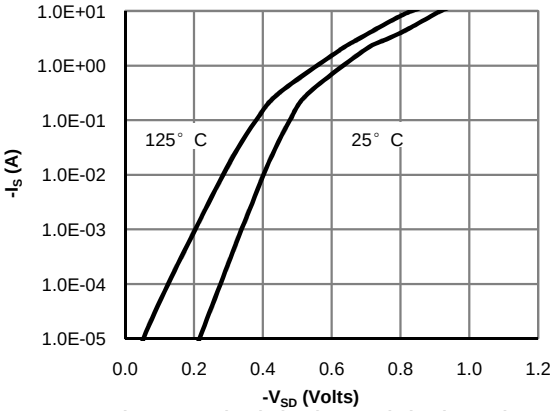


Figure 6: Body-Diode Characteristics (Note E)

AO3415 Typical Characteristics

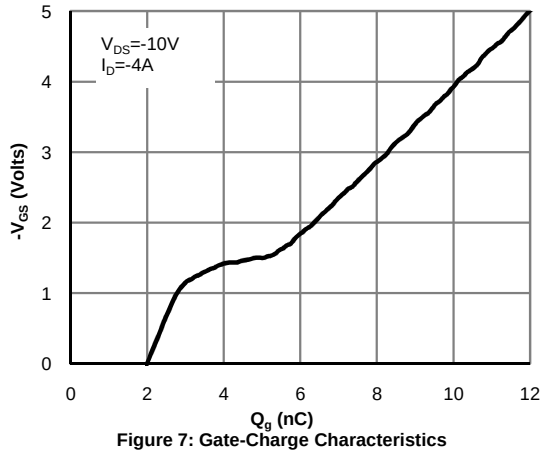


Figure 7: Gate-Charge Characteristics

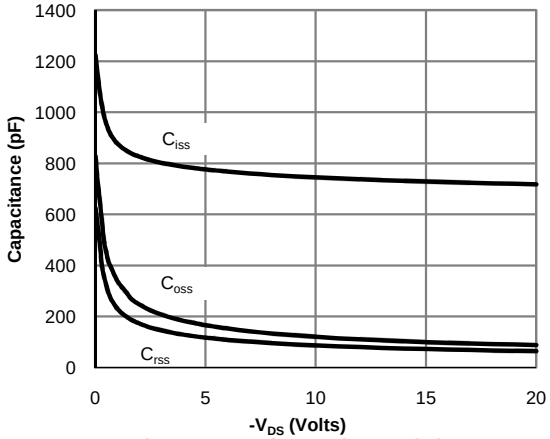


Figure 8: Capacitance Characteristics

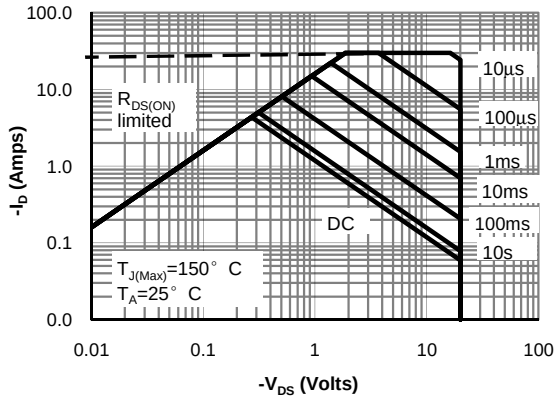


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

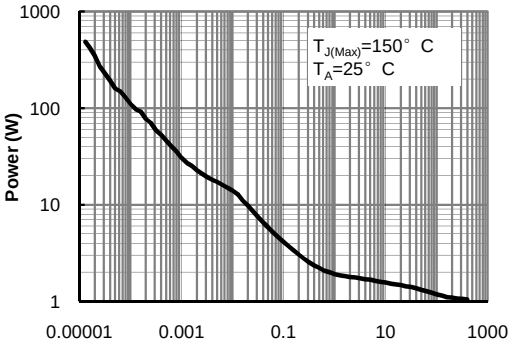


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

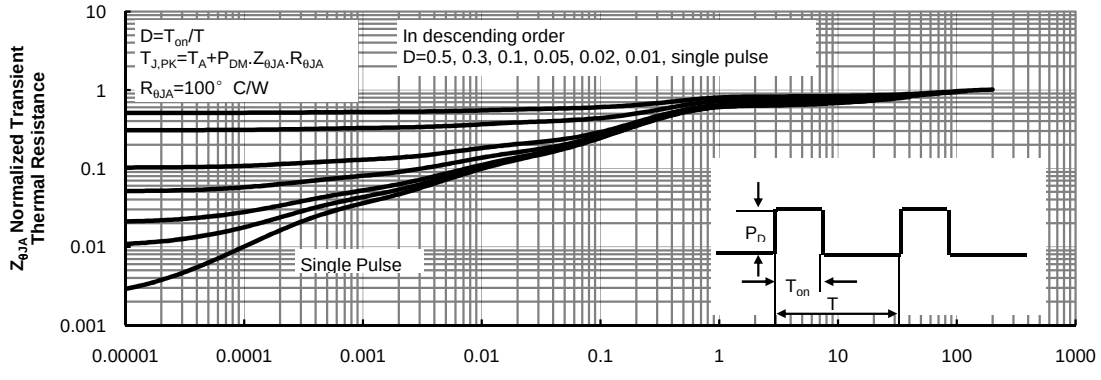


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

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